SolidMatrix® Surface Mount Fuses

F1206SB Series (Slow Blow, 1206 Size)

Features:

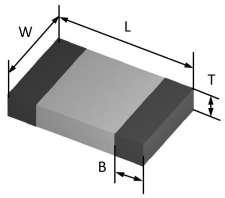
- High inrush current withstanding capability
- Multilayer monolithic structure with glass ceramic body and silver fusing element
- Silver termination with nickel and pure-tin solder plating, providing excellent solderability
- Compatible with both wave and reflow soldering processes

Clearing Time Characteristics:

% of current rating	Clearing time at 25°C	
	Min.	Max.
100%	4 hours	-
200%	1 second	120 seconds
300%	0.1 seconds	3 seconds
800%	0.002 seconds	0. 05 seconds

Shape and Dimensions:

Unit	Inch	mm
L	0.126 ± 0.008	3.20 ± 0.20
W	0.063 ± 0.008	1.60 ± 0.20
T	0.038 ± 0.008	0.97 ± 0.20
B	0.020 ± 0.010	0.51 ± 0.25



Applications:

- Power tools
- DC-DC convert
- Display
- PC
- Notebook
- Server
- Battery pack
- Set top box

Ordering Information:

Part Number	Current Rating (A)	Voltage Rating (V DC)	Interrupting Ratings	Nominal Cold DCR (Ω)[1]	Nominal I^2t (A^2s)[2]	Marking Code[3]
F1206SB1000V063TM	1.0	63	50 A at rated voltage	0.360	0.11	E
F1206SB1250V063TM	1.25	63		0.200	0.22	F
F1206SB1500V063TM	1.5	63		0.150	0.23	G
F1206SB2000V063TM	2.0	63		0.088	0.63	I
F1206SB2500V032TM	2.5	32		0.065	0.90	J
F1206SB3000V032TM	3.0	32		0.034	1.20	K
F1206SB3500V032TM	3.5	32		0.028	1.60	L
F1206SB4000V032TM	4.0	32		0.024	2.20	M
F1206SB4500V032TM	4.5	32		0.020	3.60	T
F1206SB5000V032TM	5.0	32		0.018	5.30	N
F1206SB5500V024TM	5.5	24		0.014	6.40	U
F1206SB6000V024TM	6.0	24	60 A at rated voltage	0.011	8.50	O
F1206SB7000V024TM	7.0	24		0.010	10.0	P
F1206SB8000V024TM	8.0	24		0.009	16.9	R

1. Measured at ≤10% rated current and 25 °C ambient
2. Melting I^2t at 0.001 second pre-arcing time.
3. Red marking character code.

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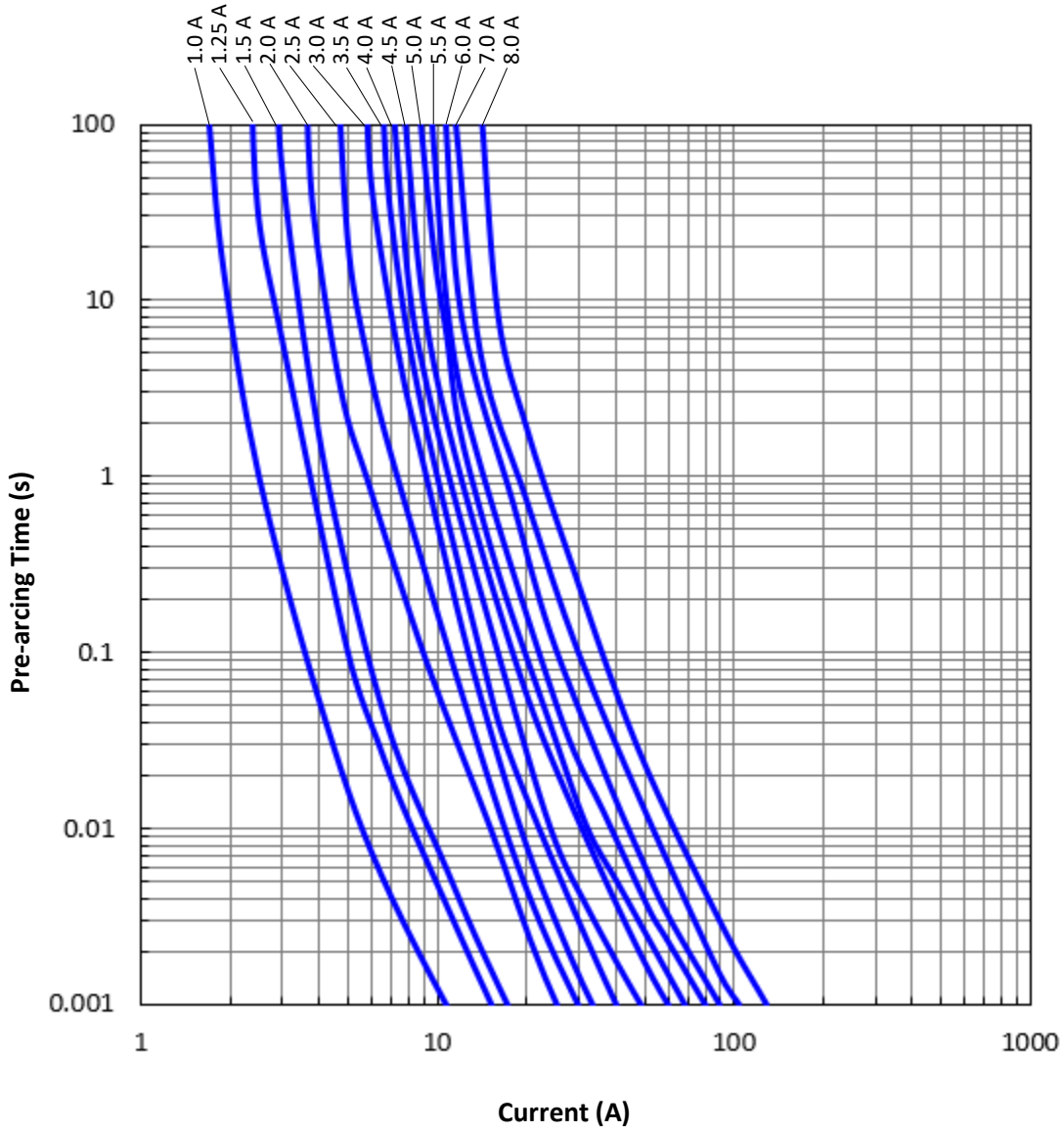
Average Pre-arcing Time Curves:



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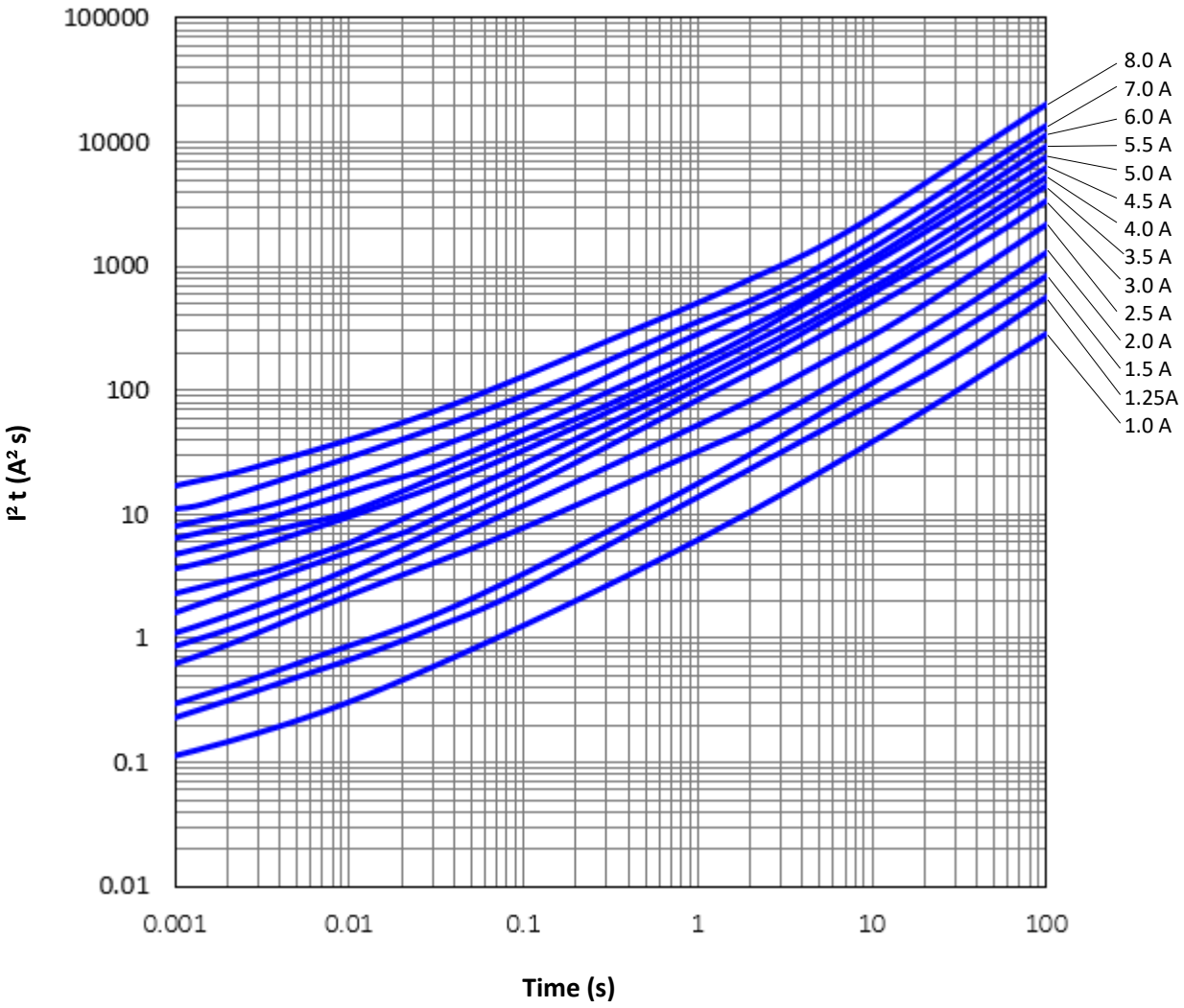
Average I^2t vs. t Curves:



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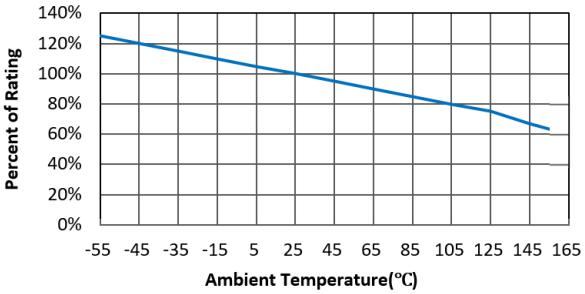
Temperature De-rating:

The ambient temperature affects the current carrying capacity of fuses. When a fuse is operating at a temperature higher than 25°C , the fuse shall be "de-rated" according to the de-rating curve.



Product Identification:

F 1206 SB 1000 V063 T M

(1) (2) (3) (4) (5) (6)(7)

(1) Series Code: SolidMatrix Surface Mount Fuses

(2) Size Code: L x W (inch), the first two digits - L (length), the last two digits - W (width)

(3) Characteristic Code: SB - Slow Blow

(4) Current Rating Code: 1000 - 1000 mA

(5) Voltage Rating code: V063 - 63V DC

(6) Package Code: T - Tape & Reel, B - Bulk

(7) Marking Code: M - With marking

Operating Temperature Range:

- -55°C ~+150°C (with de-rating)

Agency Approval:

- Recognized Under the Components Program of Underwriters Laboratories.
- Certification #: UL-E232989

Reliability Tests:

No.	Item	Condition	Criteria
1	Bend	2 mm bend	DCR change within ±20%. (±10% for ≤1A), no mechanical damage
2	Solderability	245°C, 5 seconds	New solder coverage ≥95%
3	Soldering Heat Resistance	260°C, 60 seconds	DCR change within ±10%, new solder coverage 75% minimum, no mechanical damage
4	Terminal Strength	Gradually apply 0.5 kg force to the side of the part for 60 seconds	DCR change within ±10%, no mechanical damage
5	Life	80% rated current (75% for <1A), 2000 hours, ambient temperature +20°C to +30°C	Voltage drop change within ±10%
6	Thermal Shock	-65°C to +150°C, 100 cycles	DCR change within ±10%, no mechanical damage
7	Mechanical Vibration	5 – 3000 Hz, 0.4 inch double amplitude or 30 G peak	DCR change within ±10%, no mechanical damage
8	Mechanical Shock	1500 G, 0.5 milliseconds, half-sine shocks	DCR change within ±10%, no mechanical damage
9	Salt Spray	5% salt solution, 48 hours exposure	DCR change within ±10%, no excessive corrosion
10	Moisture Resistance	10 cycles	DCR change within ±10%, no excessive corrosion

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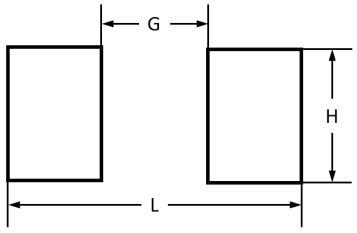
Recommended Land Pattern:

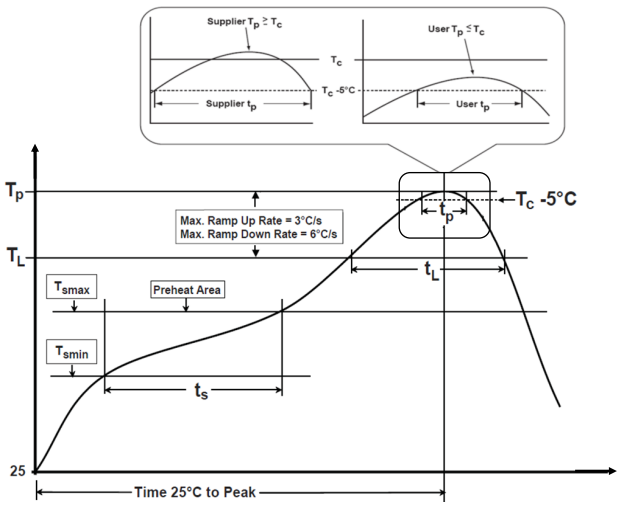
Chip Size	1206	Unit
L	0.173 (4.40)	Inch (mm)
G	0.059 (1.50)	Inch (mm)
H	0.071 (1.80)	Inch (mm)



Recommended Temperature Profile:

Profile Feature	Pb-Free Assembly
Preheat/Soak Temperature Min (T_{smin}) Temperature Max (T_{smax}) Time (t_s) from (T_{smin} to T_{smax})	 150°C 200°C 60~120 seconds
Ramp-uprate (T_L to T_p)	3°C/second max.
Liquidous temperature (T_L) Time (t_L) maintained above T_L	217°C 60~150 seconds
Peak package body temperature (T_p)	260°C
Time (t_p)*within 5°C of the specified classification temperature (T_c)	30 seconds *
Ramp-down rate (T_p to T_L)	6°C/second max.
Time 25°C to peak temperature	8 minutes max.
* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum	

* Recommended Temperature Profile for Reflow Soldering



Recommended conditions for hand soldering:

1. Appropriate temperature (max.) of soldering iron tip/soldering time (max.): 280°C /10 s or 350°C / 3 s
2. Using hot air rework station with tip that can melt the solder on both terminations at the same time is strongly recommended. Do not directly contact the chip termination with the tip of soldering iron.

Storage:

1. The maximum ambient temperature shall not exceed 35°C . Storage temperatures higher than 35°C could result in the deformation of packaging materials.
2. The maximum relative humidity recommended for storage is 75%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.
3. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.
4. MSL=1

Packaging:

Chip Size	Parts on 7 inch (178 mm) Reel
1206	3,000

Disclaimer

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AEM Components (Suzhou) Co., Ltd

461 Zhongnan Street,
China-Singapore Suzhou Industrial Park
Jiangsu, P. R. China, 215026

Tel: 86-512-6258-0028
Fax: 86-512-6258-0018
Email: marketing@aemchina.com

AEM Components (USA), Inc.

6670 Cobra Way, San Diego, CA 92121, USA

Tel: 1-858-750-6100
Fax: 1-858-481-1123
Email: sales@aemcomponents.com